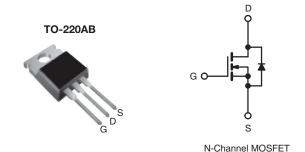


Vishay Siliconix

### **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	900	900			
$R_{DS(on)}(\Omega)$	V <sub>GS</sub> = 10 V	3.7			
Q <sub>g</sub> (Max.) (nC)	78	78			
Q <sub>gs</sub> (nC)	10	10			
Q <sub>gd</sub> (nC)	42	42			
Configuration	Sing	Single			



### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- · Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC



### **DESCRIPTION**

Third generation MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universially preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	IRFBF30PbF		
Lead (FD)-life	SiHFBF30-E3		
SnPb	IRFBF30		
SIFD	SiHFBF30		

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMITE	UNIT	
Drain-Source Voltage			$V_{DS}$	900	V	
Gate-Source Voltage			$V_{GS}$	± 20	7 v	
Continuous Drain Current	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25  ^{\circ}{\rm C}$ $T_{\rm C} = 100  ^{\circ}{\rm C}$	,	3.6		
	VGS at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	2.3	Α	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	14		
Linear Derating Factor				1.0	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	250	mJ	
Repetitive Avalanche Currenta			I <sub>AR</sub>	3.6	А	
Repetitive Avalanche Energy <sup>a</sup>			$E_{AR}$	13	mJ	
Maximum Power Dissipation $T_C = 25  ^{\circ}C$			$P_{D}$	125	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	1.5	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature) for 10 s				300 <sup>d</sup>	7 ~	
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in	
				1.1	N⋅m	

#### Notos

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 36 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 3.6 A (see fig. 12).
- c.  $I_{SD} \le 3.6$  A,  $dI/dt \le 70$  A/ $\mu$ s,  $V_{DD} \le 600$ ,  $T_{J} \le 150$  °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	$R_{thJA}$	-	62		
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.50	-	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	1.0		

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static		•					
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 250 μA	900	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	ce to 25 °C, I <sub>D</sub> = 1 mA	-	1.1	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	,	V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
Zana Cata Valta da Duais Comunit	I <sub>DSS</sub>	V <sub>DS</sub> = 900 V, V <sub>GS</sub> = 0 V		-	-	100	μА
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 720 V	V <sub>DS</sub> = 720 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C		-	500	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 2.2 A <sup>b</sup>	-	-	3.7	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	100 V, I <sub>D</sub> = 2.2 A <sup>b</sup>	2.3	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V,	-	1200	-	pF
Output Capacitance	C <sub>oss</sub>	]	$V_{DS} = 25 \text{ V},$	-	320	-	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.	f = 1.0 MHz, see fig. 5		200	-	1
Total Gate Charge	Qg			-	-	78	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 3.6 \text{ A}, V_{DS} = 360 \text{ V},$ see fig. 6 and 13 <sup>b</sup>		-	10	
Gate-Drain Charge	Q <sub>gd</sub>	1			-	42	
Turn-On Delay Time	t <sub>d(on)</sub>			-	14	-	
Rise Time	t <sub>r</sub>	$V_{DD} = 450 \text{ V}, I_D = 3.6 \text{ A},$ $R_g = 12 \Omega, R_D = 120 \Omega, \text{ see fig. } 10^{\text{b}}$		-	25	-	ns
Turn-Off Delay Time	t <sub>d(off)</sub>			-	90	-	
Fall Time	t <sub>f</sub>			-	30	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	-11
Internal Source Inductance	L <sub>S</sub>			-	7.5	-	- nH
Drain-Source Body Diode Characteristic	es						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	3.6	Α
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	14	
Body Diode Voltage	$V_{SD}$	$T_J = 25  ^{\circ}\text{C},  I_S = 3.6  \text{A},  V_{GS} = 0  \text{V}^{\text{b}}$		-	=	1.8	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = 3.6 A, dI/dt = 100 A/μs <sup>b</sup>		-	430	650	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	1.4	2.1	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is			n-on is dominated by L <sub>S</sub> and L <sub>D</sub> )		

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq$  300  $\mu$ s; duty cycle  $\leq$  2 %.



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

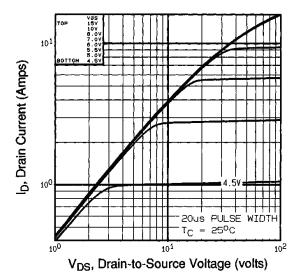


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

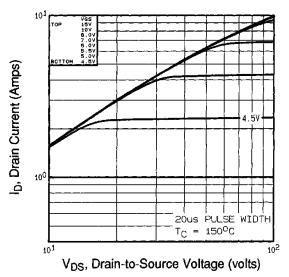
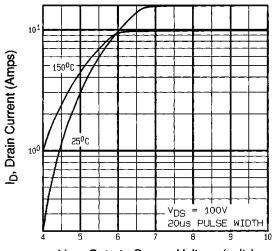


Fig. 2 -Typical Output Characteristics, T<sub>C</sub> = 150 °C



V<sub>GS</sub>, Gate-to-Source Voltage (volts)



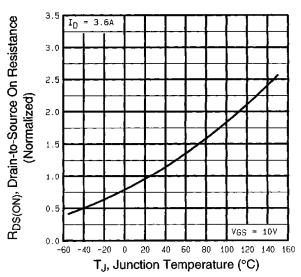


Fig. 4 - Normalized On-Resistance vs. Temperature

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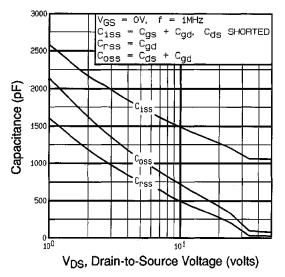


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

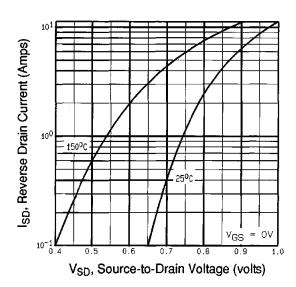


Fig. 7 - Typical Source-Drain Diode Forward Voltage

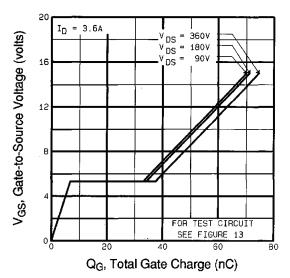


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

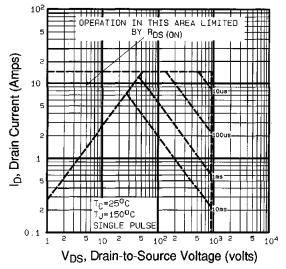


Fig. 8 - Maximum Safe Operating Area





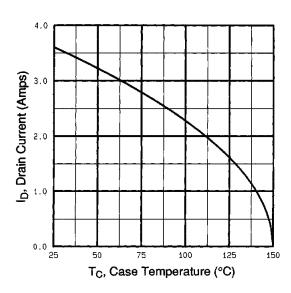


Fig. 9 - Maximum Drain Current vs. Case Temperature

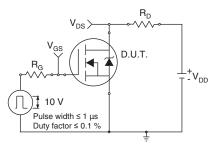


Fig. 10a - Switching Time Test Circuit

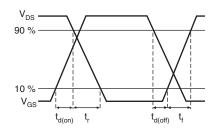


Fig. 10b - Switching Time Waveforms

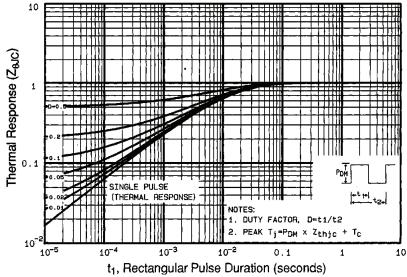


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

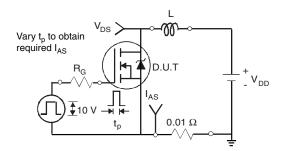


Fig. 12a - Unclamped Inductive Test Circuit

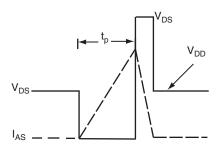


Fig. 12b - Unclamped Inductive Waveforms



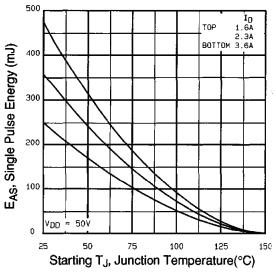


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

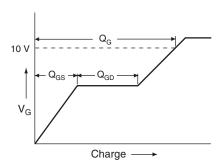


Fig. 13a - Basic Gate Charge Waveform

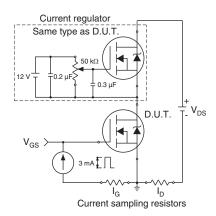
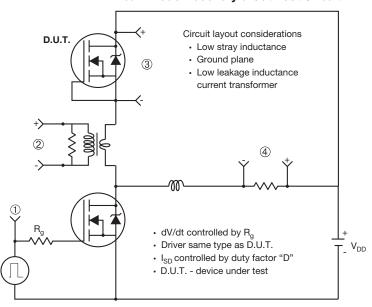


Fig. 13b - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



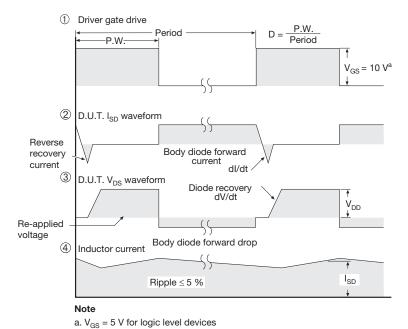


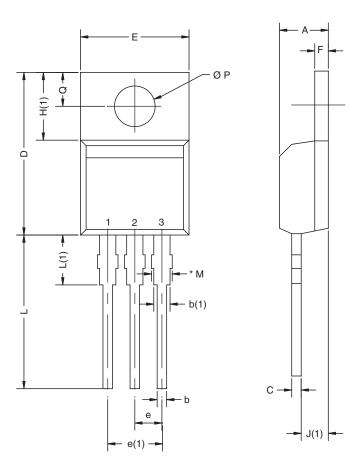
Fig. 14 - For N-Channel

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### **TO-220AB**



	MILLI	METERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØР	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	

DWG: 5471

\* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM

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